

# United States Patent [19]

**Kawakami**

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[54] **ACOUSTICALLY COUPLED MODEM**

[75] Inventor: **Yoshikazu Kawakami, Shiojiri, Japan**

[73] Assignees: **Kabushiki Kaisha Epson Corporation, Tokyo; Suwa Seikosha, Nagano, both of Japan**

[\*\*] Term: **14 Years**

[21] Appl. No.: **368,772**

[22] Filed: **Apr. 15, 1982**

[30] **Foreign Application Priority Data**

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[52] U.S. Cl. .... **D14/57; D14/101; D14/52**

[58] Field of Search ..... **D14/57, 59, 60, 101, D14/57; 179/2 DD, 2 C, 2 DP, 6.12, 6.2, 2 C**

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*Primary Examiner*—Wallace R. Burke

*Assistant Examiner*—Horace B. Fay

*Attorney, Agent, or Firm*—Blum, Kaplan, Friedman, Silberman & Beran

[57] **CLAIM**

The ornamental design for acoustically coupled modem, as shown.

**DESCRIPTION**

FIG. 1—is a top plan view of acoustically coupled modem in accordance with my new design;

FIG. 2—is a front elevational view thereof;

FIG. 3—is a left side view thereof;

FIG. 4—is a bottom plan view thereof;

FIG. 5—is a rear elevational view thereof; and

FIG. 6—is a right side view thereof.

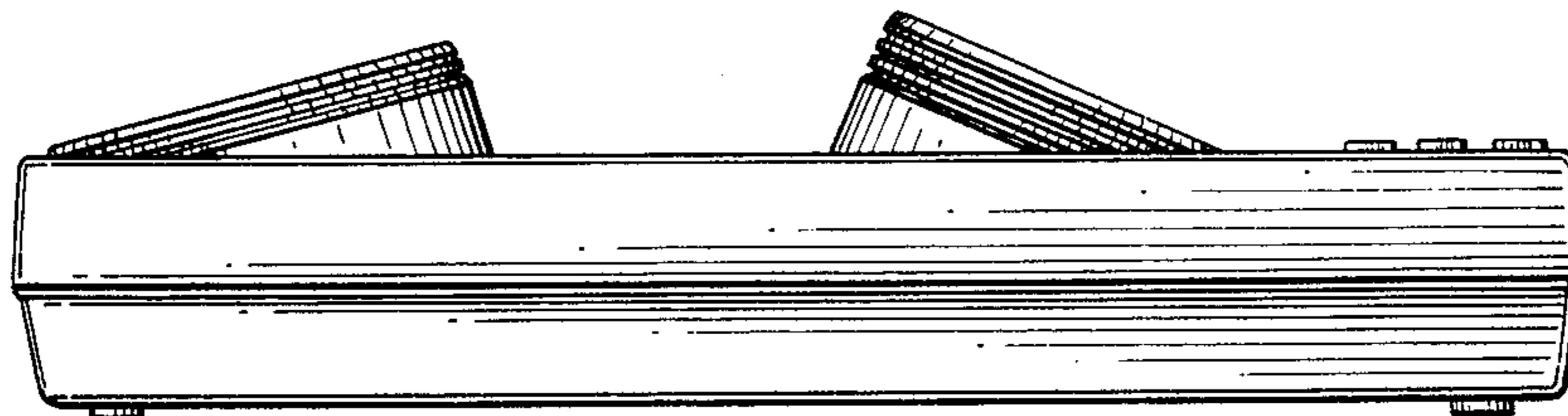
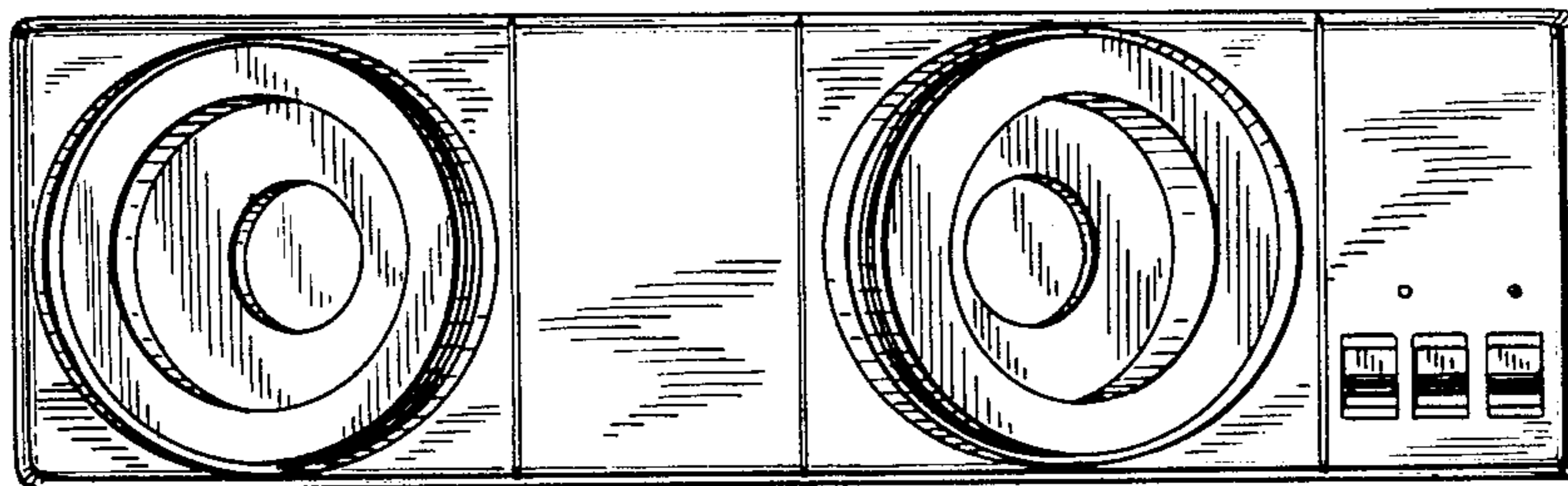


FIG. 1

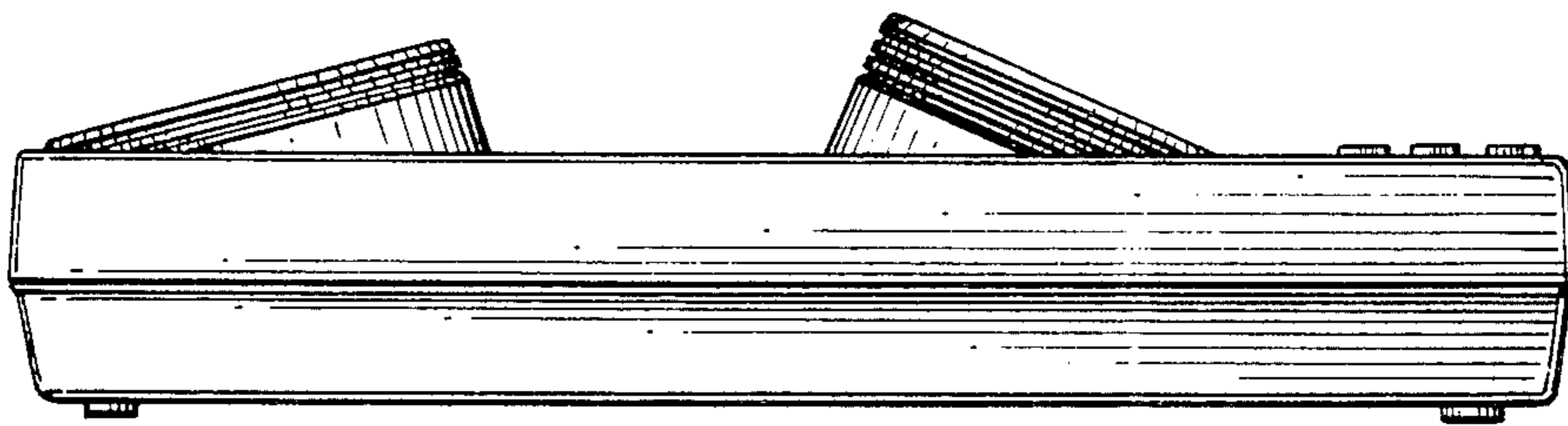
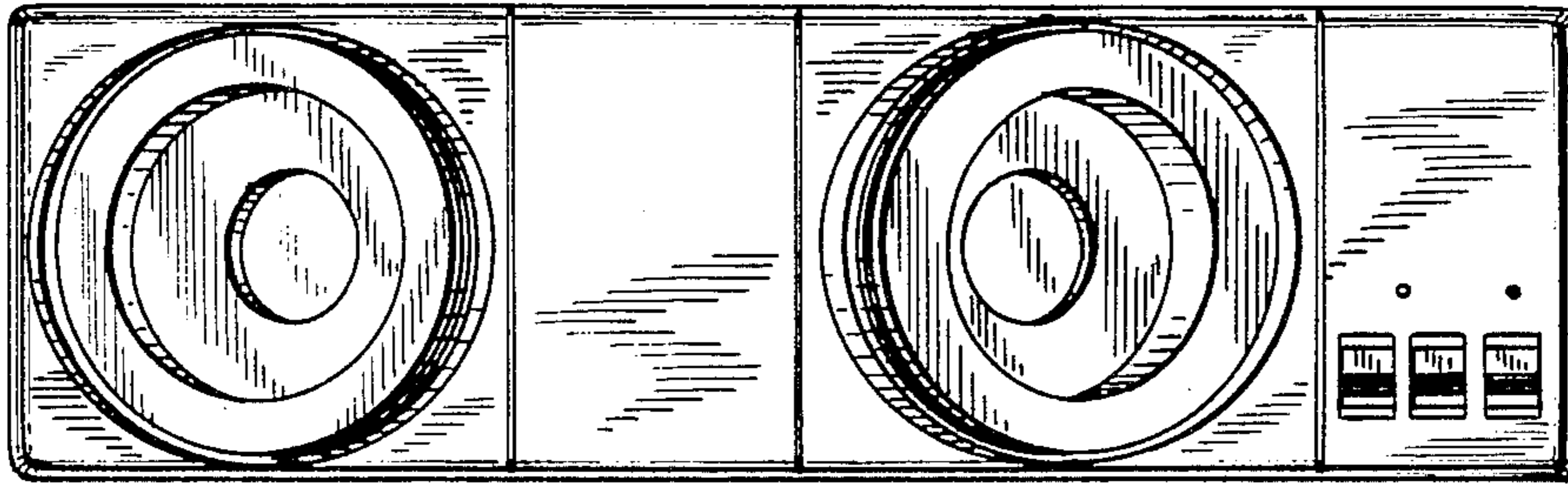


FIG. 2

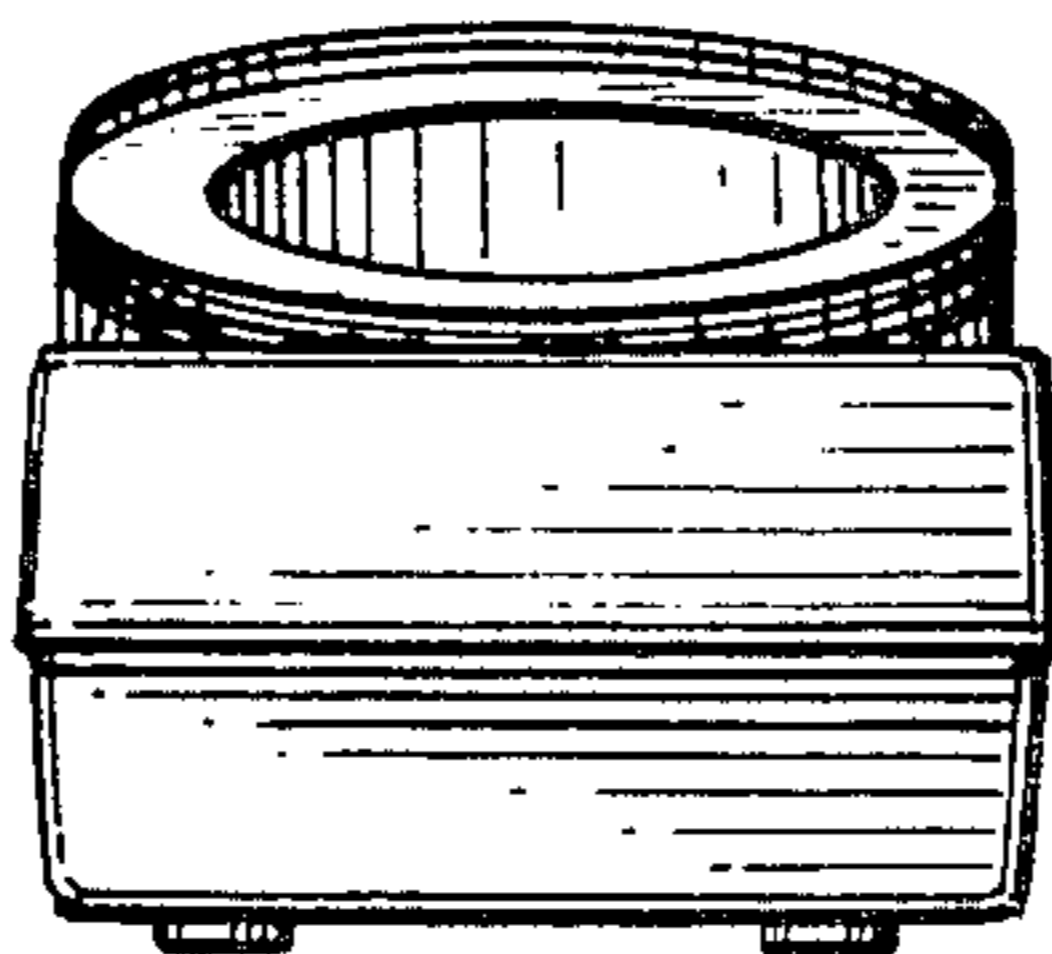
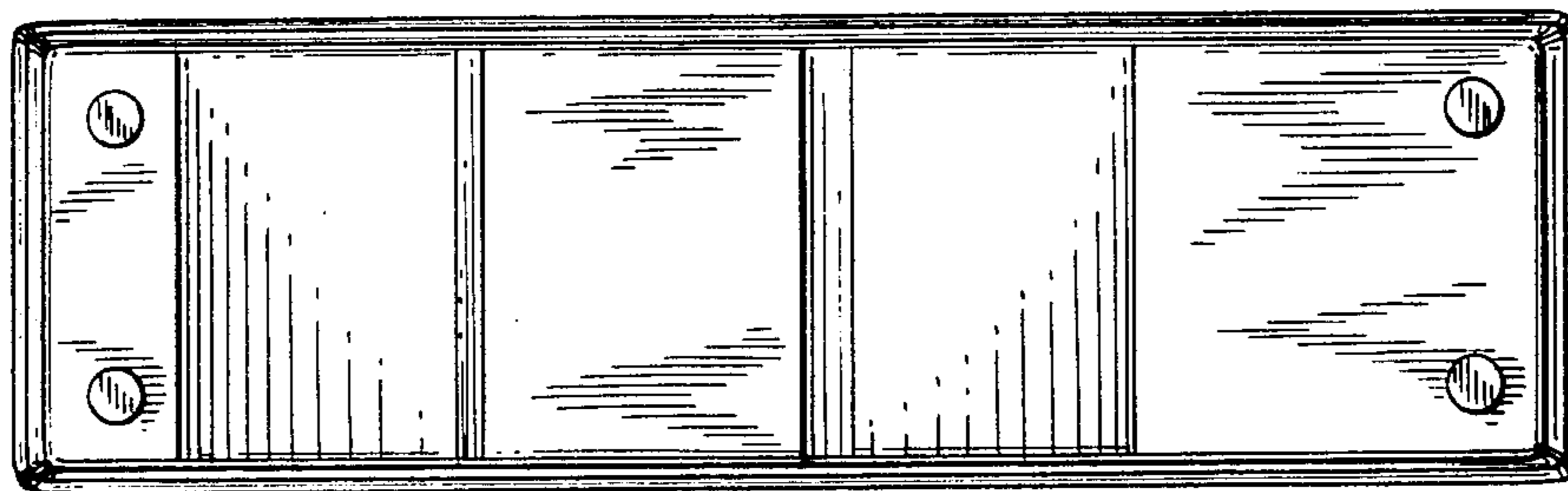
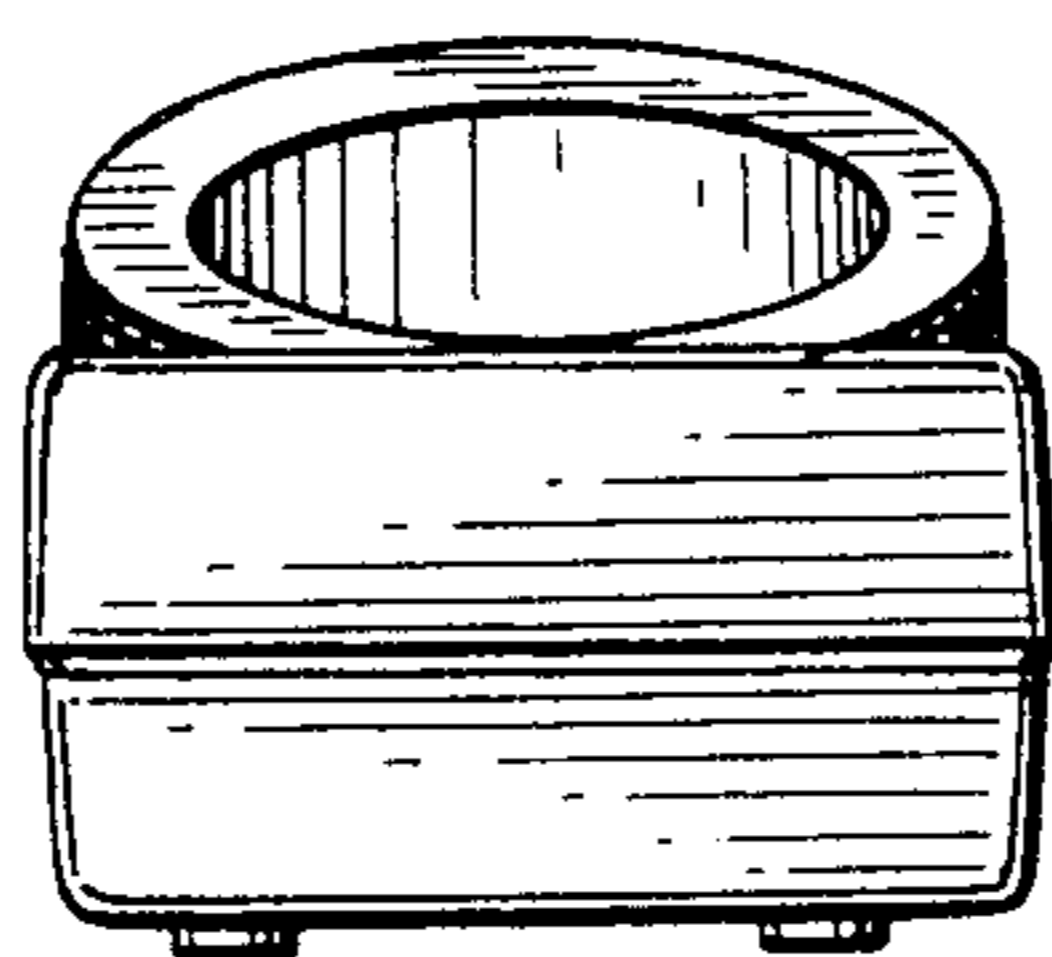
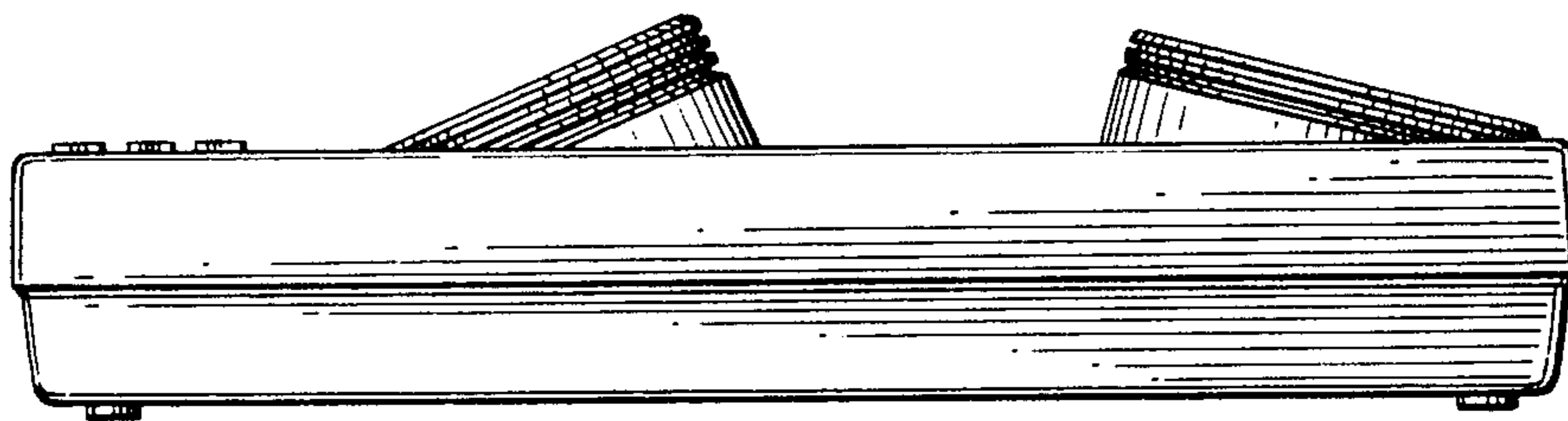


FIG. 3

*FIG. 4*



*FIG. 5*



*FIG. 6*